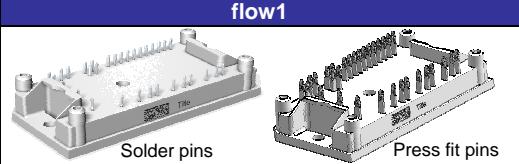
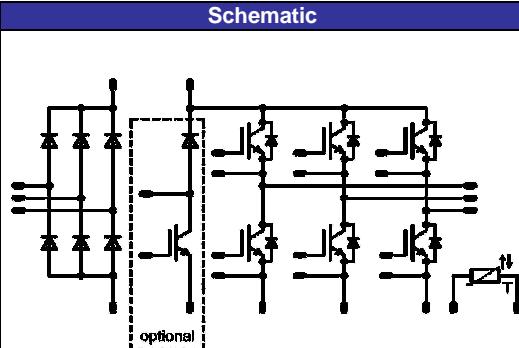


flow1	600V/30A
Features	flow1
<ul style="list-style-type: none"> <li>• 3~rectifier, optional BRC, Inverter, NTC</li> <li>• Very compact housing, easy to route</li> <li>• IGBT4 / EmCon4 technology for low saturation losses and improved EMC behaviour</li> </ul>	
Target Applications	Schematic
<ul style="list-style-type: none"> <li>• Industrial drives</li> <li>• Embedded drives</li> </ul>	
Types	
<ul style="list-style-type: none"> <li>• V23990-P585-A20-PM</li> <li>• V23990-P585-A20Y-PM</li> <li>• V23990-P585-A208-PM</li> <li>• V23990-P585-C20-PM</li> <li>• V23990-P585-C20Y-PM</li> </ul>	

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	33 47	A
Surge forward current	$I_{FSM}$	$t_p=10\text{ms}$ 50 Hz half sine wave	250	A
$I^2t$ -value	$I^2t$	$T_j=25^\circ\text{C}$	310	$\text{A}^2\text{s}$
Power dissipation per Diode	$P_{\text{tot}}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	37 60	W
Maximum Junction Temperature	$T_{j\max}$		150	$^\circ\text{C}$

## Inverter Transistor

Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	30 39	A
Pulsed collector current	$I_{Cpulse}$	$t_p$ limited by $T_{j\max}$	90	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$ , $T_j \leq T_{op\max}$	90	A
Power dissipation per IGBT	$P_{\text{tot}}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	55 84	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{j\max}$		175	$^\circ\text{C}$

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	25 33	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\max$	60	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	46 69	W
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Brake Transistor</b>				
Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	22 28	A
Pulsed collector current	$I_{Cpuls}$	$t_p$ limited by $T_j\max$	60	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$ , $T_j \leq T_{op\max}$	65	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	45 68	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	6 360	μs V
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Brake Diode</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	14 19	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\max$	40	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\max$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	20 30	W
Maximum Junction Temperature	$T_j\max$		175	°C
<b>Thermal Properties</b>				
Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{j\max} - 25$ )	°C
<b>Insulation Properties</b>				
Insulation voltage	$V_{is}$	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max	
<b>Input Rectifier Diode</b>										
Forward voltage	$V_F$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,8	1,16 1,13	1,6	V
Threshold voltage (for power loss calc. only)	$V_{to}$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,90 0,78		V
Slope resistance (for power loss calc. only)	$r_t$				30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		8 11		mΩ
Reverse current	$I_r$			1500		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			2	mA
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						1,89		K/W
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Preapplied Phase change material						1,17		K/W
<b>Inverter Transistor</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,00043	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	4,1	4,9	5,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,1	1,70 1,77	1,9	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,04 1		mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			300	nA
Integrated Gate resistor	$R_{gint}$							-		Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16 \Omega$ $R_{gon}=16 \Omega$	15	300	30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		93 93,5		ns
Rise time	$t_r$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		15 17,5		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		141 159,5		
Fall time	$t_f$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		67,1 86,7		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,42 0,63		mWs
Turn-off energy loss per pulse	$E_{off}$					$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,59 0,80		
Input capacitance	$C_{ies}$	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		1630		pF
Output capacitance	$C_{oss}$							108		
Reverse transfer capacitance	$C_{rss}$							50		
Gate charge	$Q_{Gate}$							167		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						1,6		K/W
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Preapplied Phase change material						1,37		K/W

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] or $V_{GS}$ [V]	$V_T$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_J$	Min	Typ	Max	
<b>Inverter Diode</b>										
Diode forward voltage	$V_F$				30	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	1,25	1,75 1,70	1,95	V
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=16 \Omega$	$-15$	$300$	$30$	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	29			A
Reverse recovery time	$t_{rr}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	35			ns
Reverse recovered charge	$Q_{rr}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	183			$\mu\text{C}$
Peak rate of fall of recovery current	$\frac{di(\text{rec})}{dt}$ max					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	1,20 2,16			
Reverse recovered energy	$E_{rec}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	2200 1576			$\text{A}/\mu\text{s}$
Thermal resistance chip to heatsink per chip	$R_{thJH}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	0,23 0,45			$\text{mWs}$
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						2,07		K/W
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Preapplied Phase change material						1,78		K/W
<b>Brake Transistor</b>										
Gate emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE}=V_{GE}$			0,00029	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		20	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	1,1	1,55 1,75	1,9	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	600		$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$			0,04 1	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$			300	nA
Integrated Gate resistor	$R_{gint}$							-		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=32 \Omega$ $R_{gon}=32 \Omega$	$\pm 15$	$300$	$20$	$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	126 128			ns
Rise time	$t_r$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	18 21			
Turn-off delay time	$t_{d(off)}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	161 179			
Fall time	$t_f$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	105 114			
Turn-on energy loss per pulse	$E_{on}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	0,44 0,59			mWs
Turn-off energy loss per pulse	$E_{off}$					$T_J=25^\circ\text{C}$ $T_J=125^\circ\text{C}$	0,49 0,63			
Input capacitance	$C_{ies}$	$f=1\text{MHz}$	$0$	$25$	$20$	$T_J=25^\circ\text{C}$		1100		pF
Output capacitance	$C_{oss}$							71		
Reverse transfer capacitance	$C_{rss}$							32		
Gate charge	$Q_{Gate}$		15	480	20	$T_J=25^\circ\text{C}$		120		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$						2,12		K/W
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Preapplied Phase change material						1,83		K/W

**Characteristic Values**

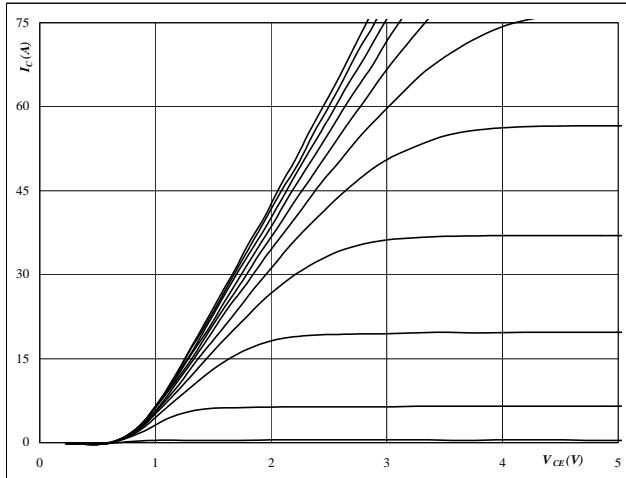
Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$		Min	Typ	Max	
<b>Brake Diode</b>										
Diode forward voltage	$V_F$			20	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,25	1,43 1,29	1,95	V	
Reverse leakage current	$I_r$		600		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$			27	$\mu\text{A}$	
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=32 \Omega$ $R_{gon}=32 \Omega$	-15	300	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	10 11			A	
Reverse recovery time	$t_{rr}$				$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	28 134			ns	
Reverse recovered charge	$Q_{rr}$				$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,29 0,29			$\mu\text{C}$	
Peak rate of fall of recovery current	$d(i_{rec})/\text{max dt}$				$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1247 443			$\text{A}/\mu\text{s}$	
Reverse recovery energy	$E_{rec}$				$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,051 0,100			$\text{mWs}$	
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$					3,53		K/W	
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Preapplied Phase change material					3,07		K/W	
<b>Thermistor</b>										
Rated resistance	R				$T_j=25^\circ\text{C}$		22000		$\Omega$	
Deviation of R25	$\Delta R/R$				$T_j=25^\circ\text{C}$	-5		5	%	
Power dissipation	P				$T_j=25^\circ\text{C}$		200		mW	
Power dissipation constant					$T_j=25^\circ\text{C}$		2		$\text{mW/K}$	
B-value	$B_{(25/50)}$	Tol. ±3%			$T_j=25^\circ\text{C}$		3950		K	
B-value	$B_{(25/100)}$				$T_j=25^\circ\text{C}$		3996		K	
Vincotech NTC Reference					$T_j=25^\circ\text{C}$			B		

## Output Inverter

**Figure 1** Output inverter IGBT

**Typical output characteristics**

$$I_C = f(V_{CE})$$



**At**

$$t_p = 250 \mu\text{s}$$

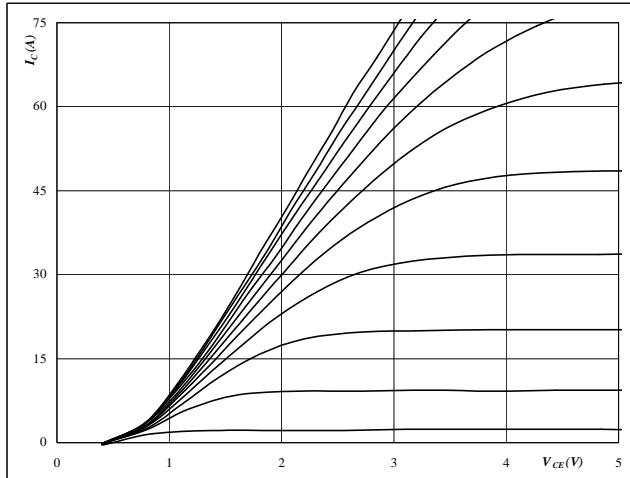
$$T_j = 25^\circ\text{C}$$

$V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2** Output inverter IGBT

**Typical output characteristics**

$$I_C = f(V_{CE})$$



**At**

$$t_p = 250 \mu\text{s}$$

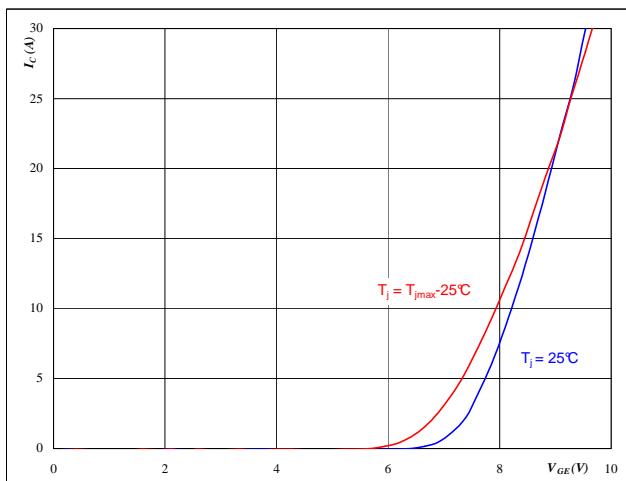
$$T_j = 125^\circ\text{C}$$

$V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3** Output inverter IGBT

**Typical transfer characteristics**

$$I_C = f(V_{GE})$$



**At**

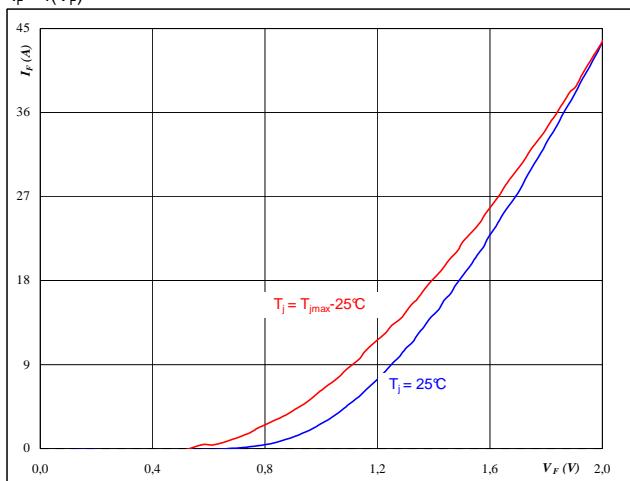
$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**Figure 4** Output inverter FWD

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$



**At**

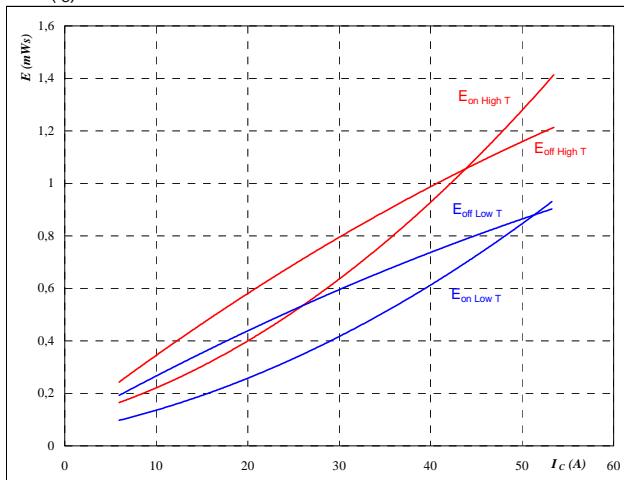
$$t_p = 250 \mu\text{s}$$

## Output Inverter

**Figure 5**

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



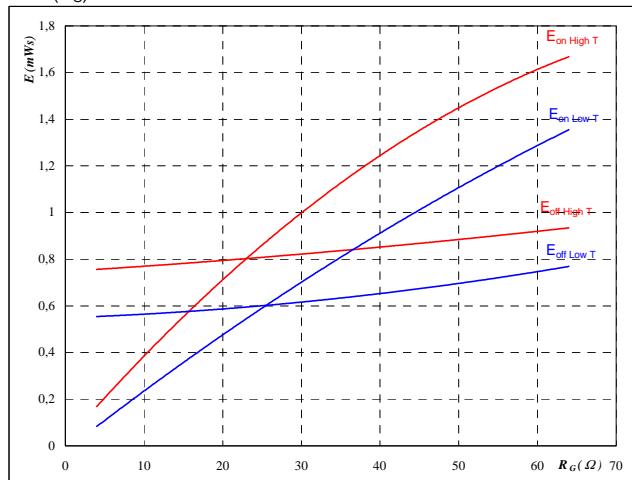
With an inductive load at

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 16 \quad \Omega \\ R_{goff} &= 16 \quad \Omega \end{aligned}$$

**Output inverter IGBT**
**Figure 6**

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



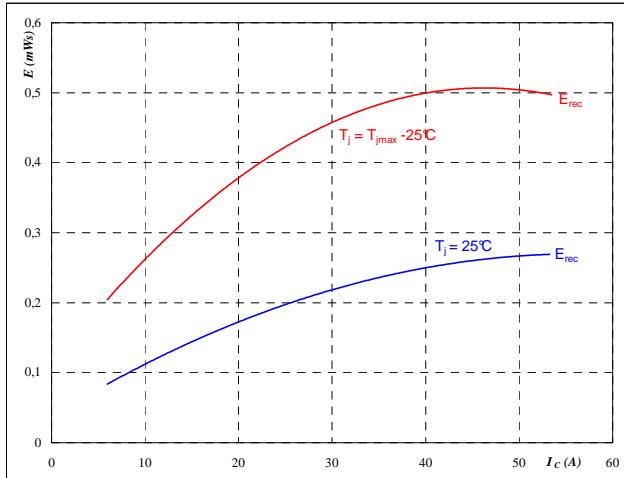
With an inductive load at

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 30 \quad \text{A} \end{aligned}$$

**Figure 7**
**Output inverter FWD**

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



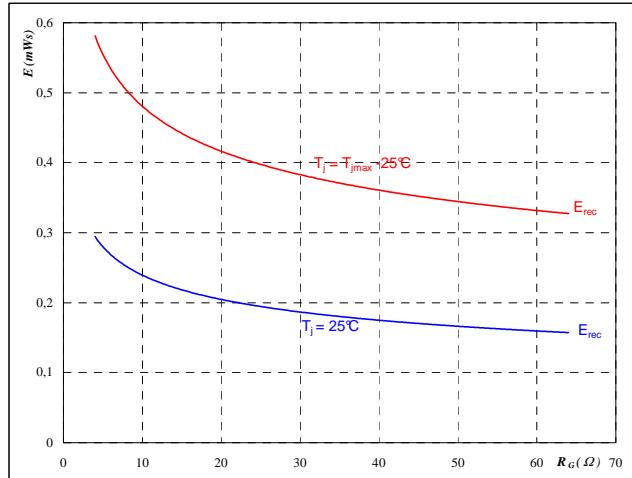
With an inductive load at

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 16 \quad \Omega \end{aligned}$$

**Figure 8**
**Output inverter FWD**

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

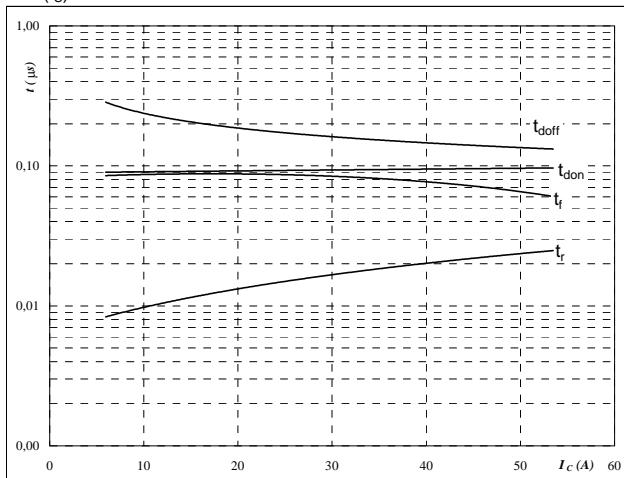
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 30 \quad \text{A} \end{aligned}$$

## Output Inverter

**Figure 9**

**Typical switching times as a function of collector current**

$$t = f(I_C)$$



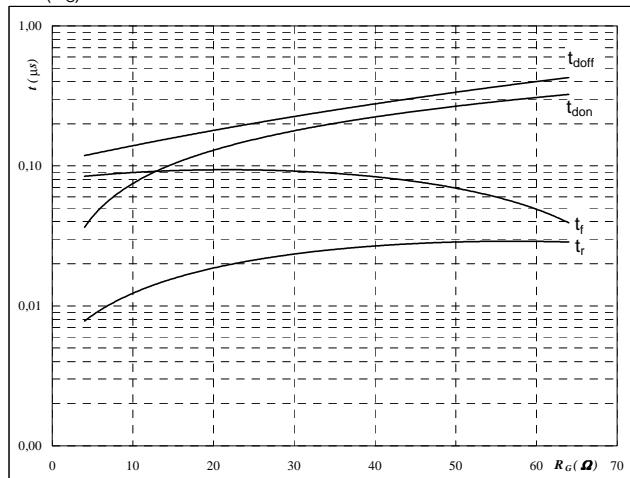
With an inductive load at

T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	±15	V
R <sub>gon</sub> =	16	Ω
R <sub>goff</sub> =	16	Ω

**Output inverter IGBT**
**Figure 10**

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



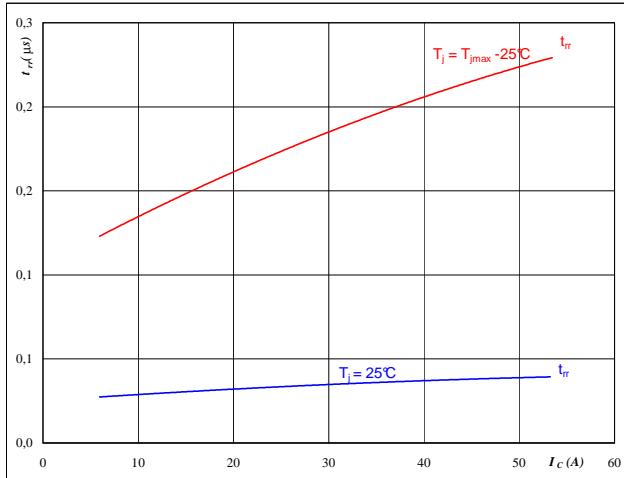
With an inductive load at

T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	±15	V
I <sub>C</sub> =	30	A

**Figure 11**
**Output inverter FWD**

**Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_C)$$



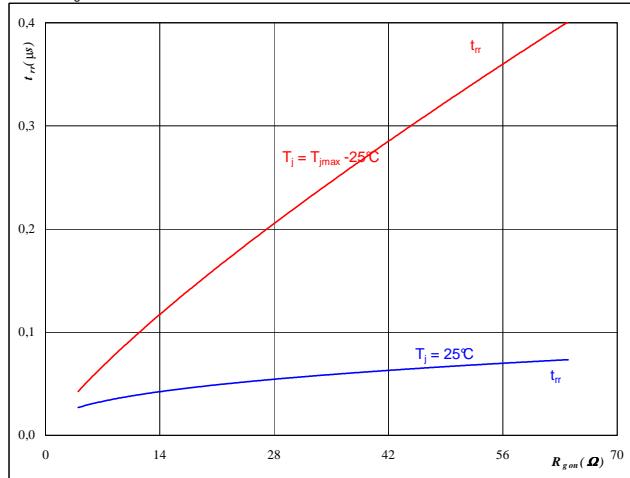
At

T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	±15	V
R <sub>gon</sub> =	16	Ω

**Figure 12**
**Output inverter FWD**

**Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$



At

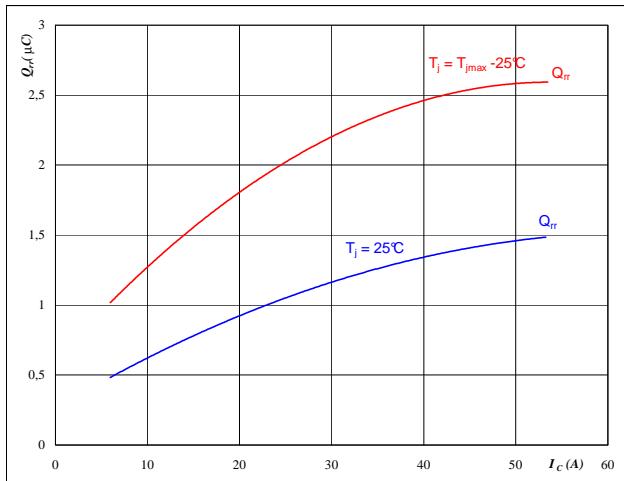
T <sub>j</sub> =	25/125	°C
V <sub>R</sub> =	300	V
I <sub>F</sub> =	30	A
V <sub>GE</sub> =	±15	V

## Output Inverter

**Figure 13**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

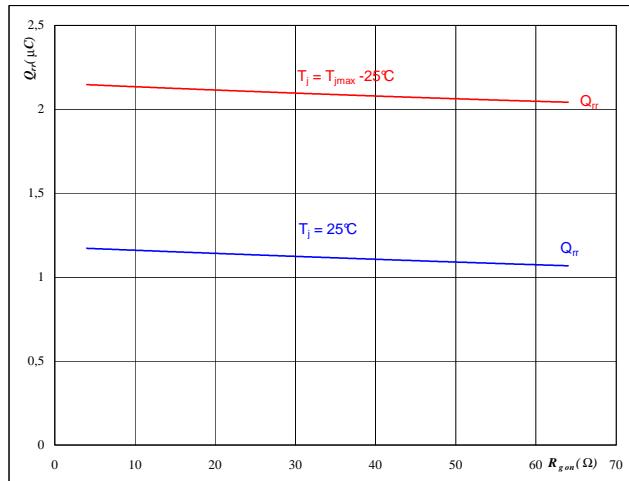

**At**

$T_j = 25/125 \quad ^\circ C$   
 $V_{CE} = 300 \quad V$   
 $V_{GE} = \pm 15 \quad V$   
 $R_{gon} = 16 \quad \Omega$

**Output inverter FWD**
**Figure 14**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

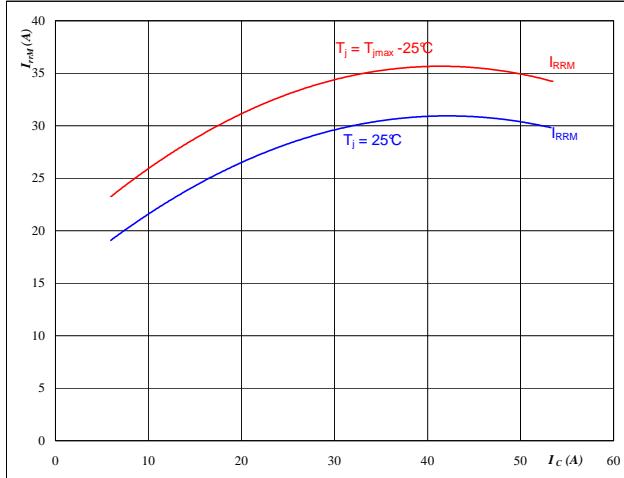

**At**

$T_j = 25/125 \quad ^\circ C$   
 $V_R = 300 \quad V$   
 $I_F = 30 \quad A$   
 $V_{GE} = \pm 15 \quad V$

**Figure 15**
**Output inverter FWD**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$

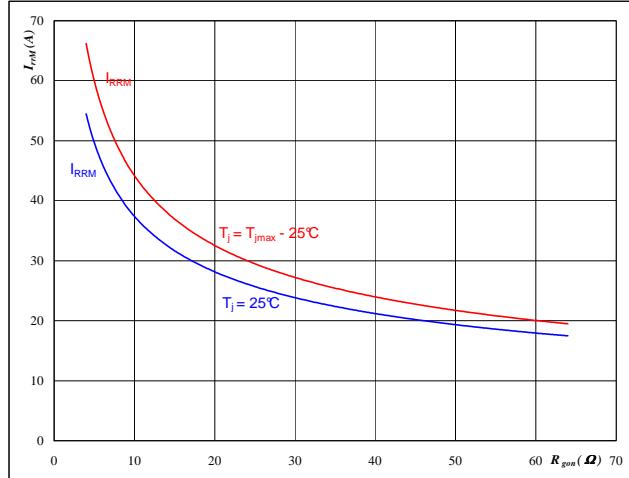

**At**

$T_j = 25/125 \quad ^\circ C$   
 $V_{CE} = 300 \quad V$   
 $V_{GE} = \pm 15 \quad V$   
 $R_{gon} = 16 \quad \Omega$

**Figure 16**
**Output inverter FWD**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

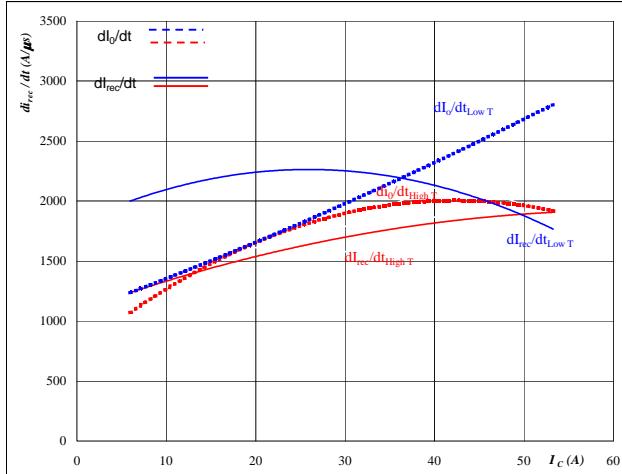

**At**

$T_j = 25/125 \quad ^\circ C$   
 $V_R = 300 \quad V$   
 $I_F = 30 \quad A$   
 $V_{GE} = \pm 15 \quad V$

## Output Inverter

**Figure 17** Output inverter FWD

Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current  
 $dI_0/dt, dI_{rec}/dt = f(I_C)$



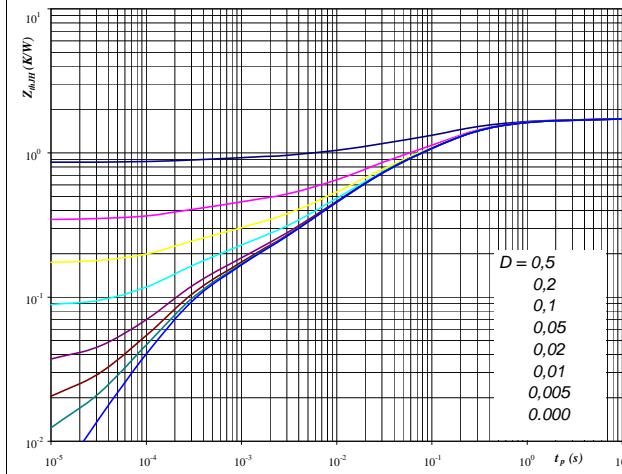
At

$T_j = 25/125 \text{ } ^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 16 \Omega$

**Figure 19** Output inverter IGBT

IGBT transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At

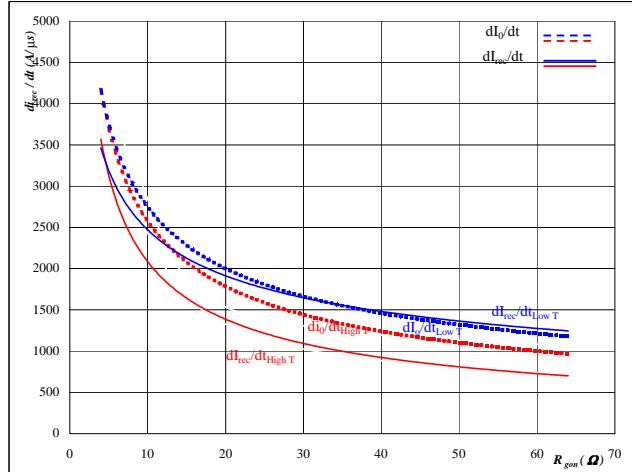
$D = t_p / T$  Phase change material  
 $R_{thJH} = 1,60 \text{ K/W}$   $R_{thJH} = 1,37 \text{ K/W}$

### IGBT thermal model values

Thermal grease		Phase change material	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,09	3,0E+00	2,57	3,0E+00
0,36	4,1E-01	0,35	4,1E-01
0,67	1,1E-01	0,10	1,1E-01
0,39	1,7E-02	0,01	1,7E-02
0,11	2,8E-03	0,00	2,8E-03
0,11	2,7E-04	0,00	2,7E-04

**Figure 18** Output inverter FWD

Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor  
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$



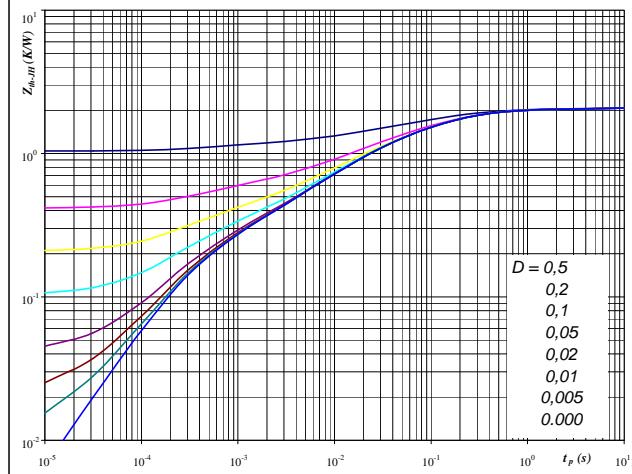
At

$T_j = 25/125 \text{ } ^\circ\text{C}$   
 $V_R = 300 \text{ V}$   
 $I_F = 30 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

**Figure 20** Output inverter FWD

FWD transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At

$D = t_p / T$  Phase change material  
 $R_{thJH} = 2,07 \text{ K/W}$   $R_{thJH} = 1,78 \text{ K/W}$

### FWD thermal model values

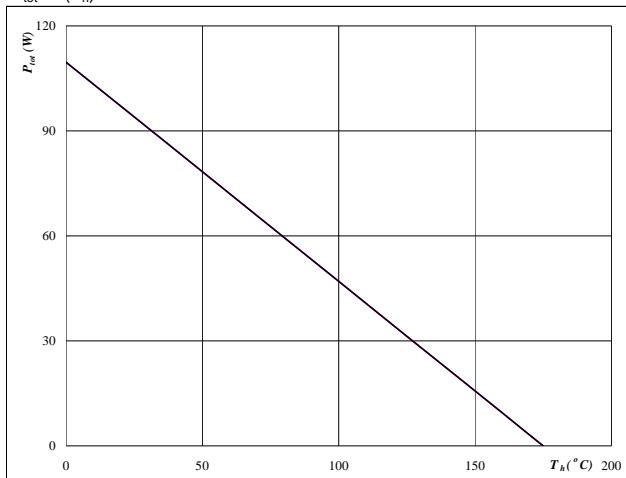
Thermal grease		Phase change material	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,09	2,7E+00	2,34	2,7E+00
0,36	3,1E-01	0,27	3,1E-01
0,72	7,9E-02	0,07	7,9E-02
0,52	1,6E-02	0,01	1,6E-02
0,21	2,8E-03	0,00	2,8E-03
0,18	3,3E-04	0,00	3,3E-04

## Output Inverter

**Figure 21**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

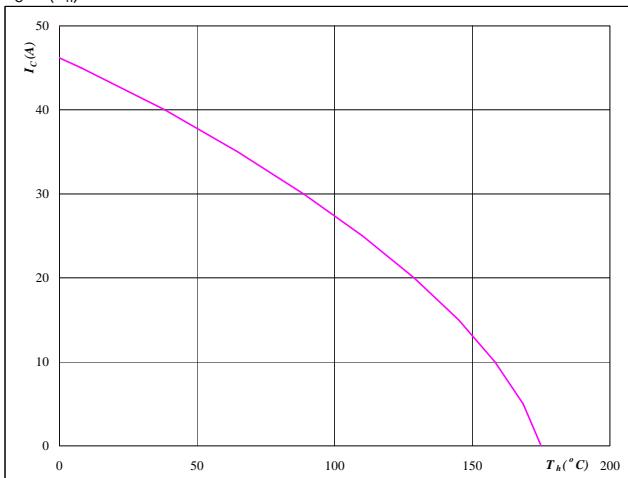

**At**

T<sub>j</sub> = 175 °C

**Output inverter IGBT**
**Figure 22**

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$

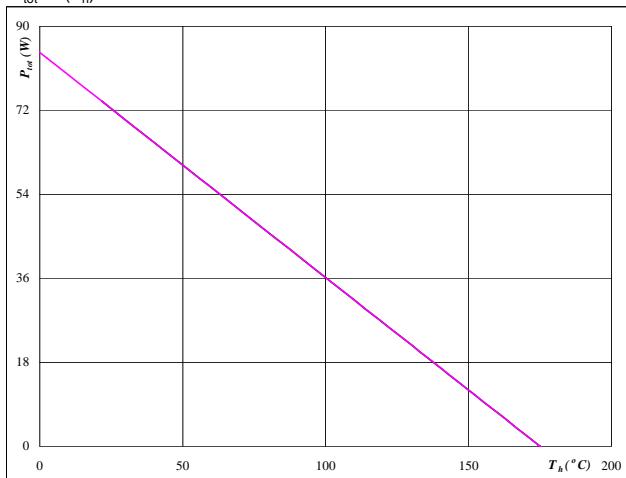

**At**

T<sub>j</sub> = 175 °C

**Output inverter IGBT**
**Figure 23**
**Output inverter FWD**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

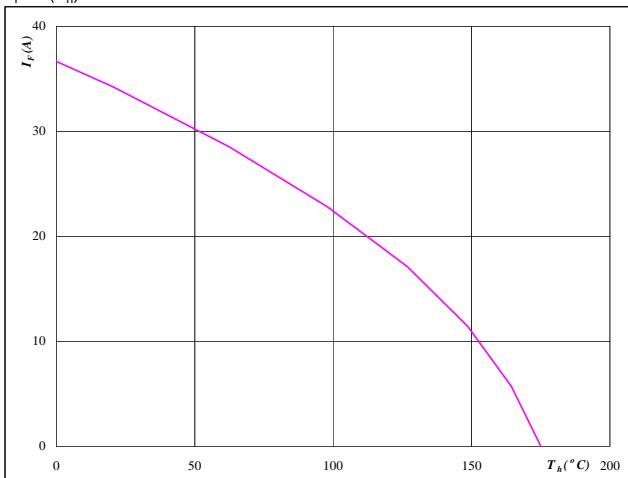

**At**

T<sub>j</sub> = 175 °C

**Figure 24**
**Output inverter FWD**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$


**At**

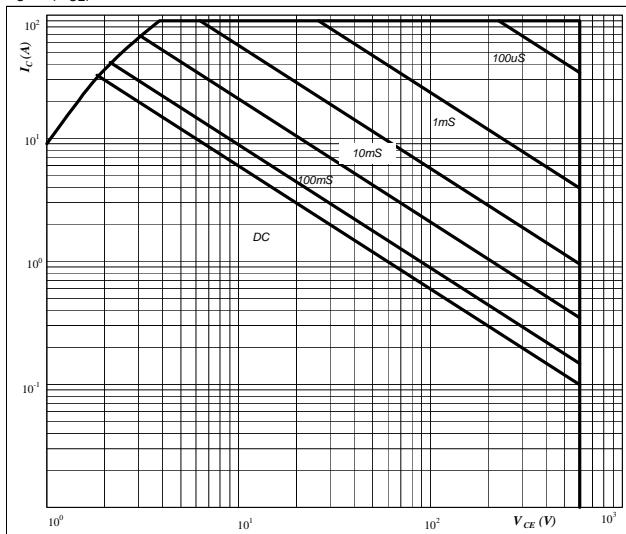
T<sub>j</sub> = 175 °C

## Output Inverter

**Figure 25**

**Safe operating area as a function of collector-emitter voltage**

$$I_C = f(V_{CE})$$


**At**

D = single pulse

T<sub>h</sub> = 80 °C

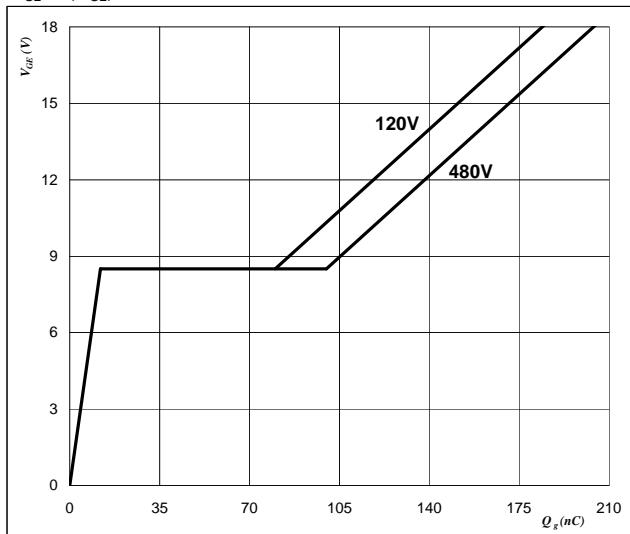
V<sub>GE</sub> = ±15 V

T<sub>j</sub> = T<sub>jmax</sub> °C

**Output inverter IGBT**
**Figure 26**

**Gate voltage vs Gate charge**

$$V_{GE} = f(Q_{GE})$$

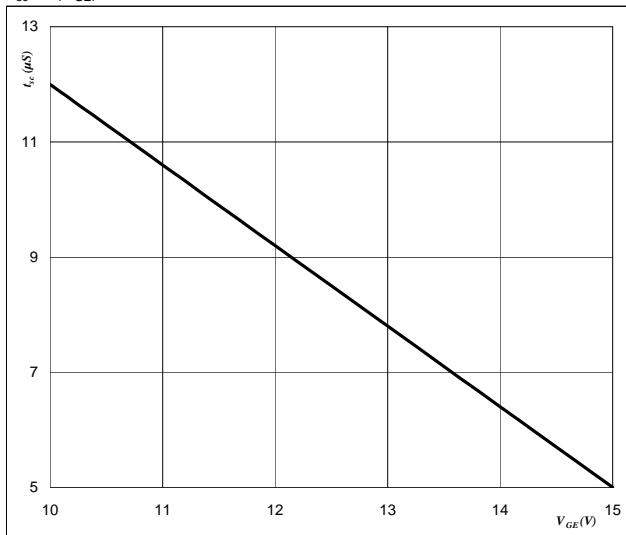

**At**

I<sub>C</sub> = 30 A

**Figure 27**
**Output inverter IGBT**

**Short circuit withstand time as a function of gate-emitter voltage**

$$t_{sc} = f(V_{GE})$$


**At**

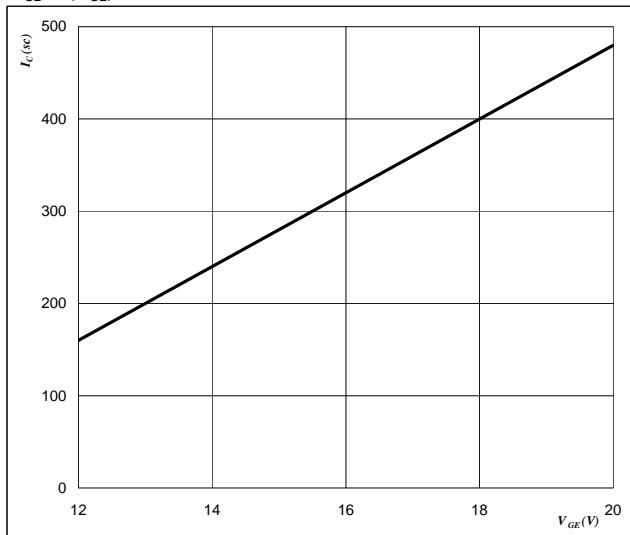
V<sub>CE</sub> = 600 V

T<sub>j</sub> ≤ 175 °C

**Figure 28**
**Output inverter IGBT**

**Typical short circuit collector current as a function of gate-emitter voltage**

$$V_{GE} = f(Q_{GE})$$

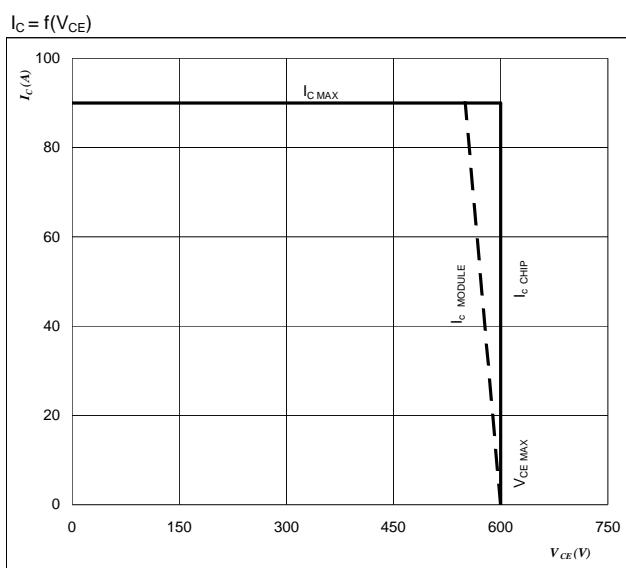

**At**

V<sub>CE</sub> ≤ 600 V

T<sub>j</sub> = 175 °C

**Figure 29**  
**Reverse bias safe operating area**

IGBT



At

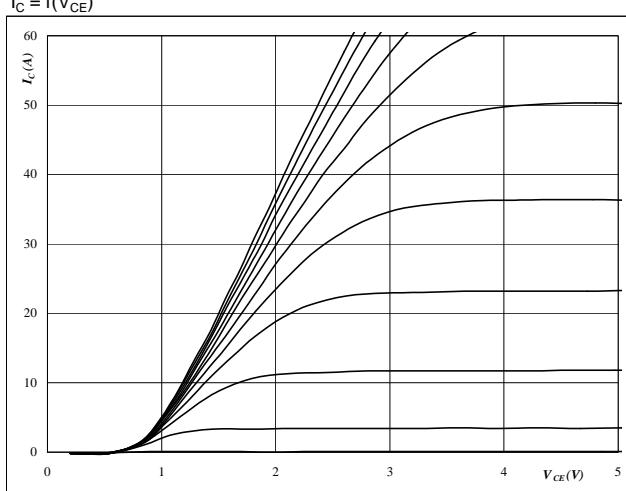
$$T_j = T_{j\max} - 25 \quad ^\circ\text{C}$$

$$U_{ccminus} = U_{ccplus}$$

Switching mode : 3 level switching

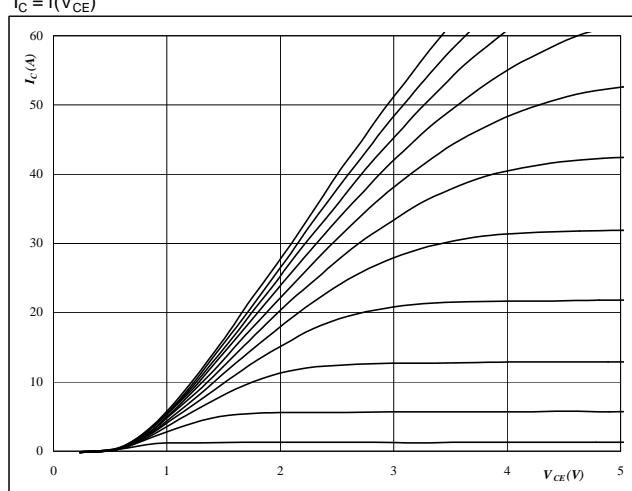
## Brake

**Figure 1**  
Typical output characteristics  
 $I_C = f(V_{CE})$



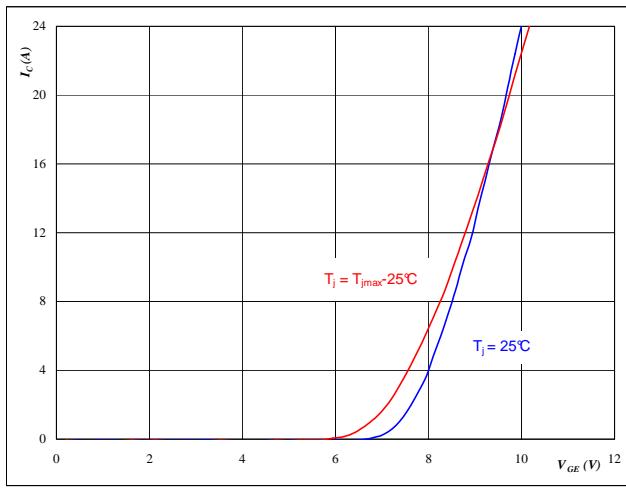
At  
 $t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2**  
Typical output characteristics  
 $I_C = f(V_{CE})$



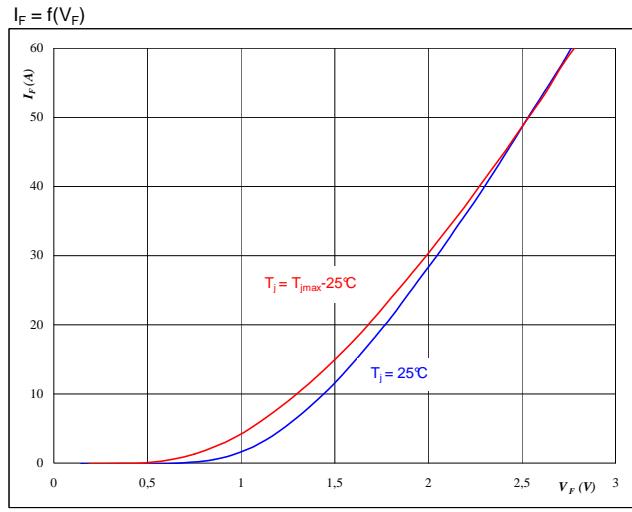
At  
 $t_p = 250 \mu s$   
 $T_j = 125^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**  
Typical transfer characteristics  
 $I_C = f(V_{GE})$



At  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

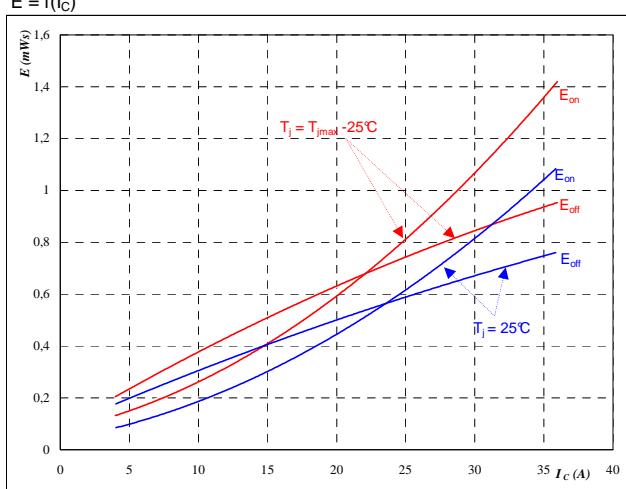
**Figure 4**  
Typical diode forward current as a function of forward voltage  
 $I_F = f(V_F)$



At  
 $t_p = 250 \mu s$

## Brake

**Figure 5**  
Typical switching energy losses  
as a function of collector current  
 $E = f(I_C)$

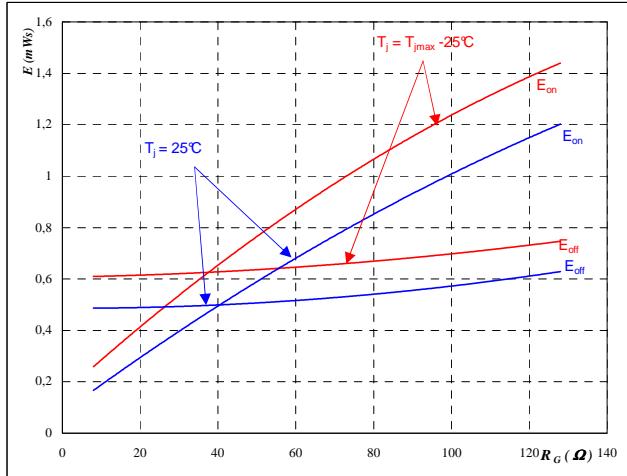


With an inductive load at

$T_j = 25/125 \text{ }^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 32 \Omega$   
 $R_{goff} = 32 \Omega$

Brake IGBT

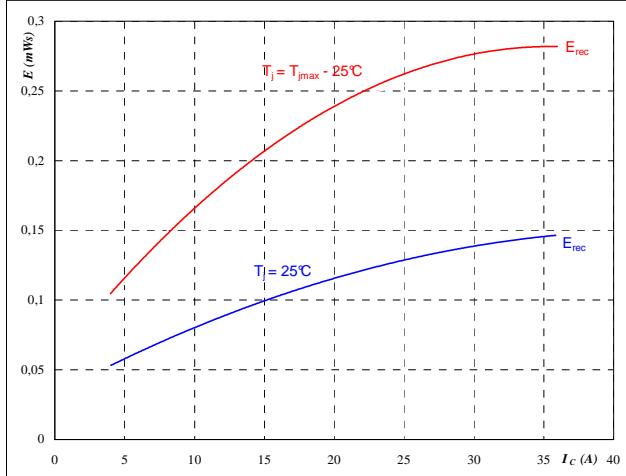
**Figure 6**  
Typical switching energy losses  
as a function of gate resistor  
 $E = f(R_G)$



With an inductive load at

$T_j = 25/125 \text{ }^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 20 \text{ A}$

**Figure 7**  
Typical reverse recovery energy loss  
as a function of collector current  
 $E_{rec} = f(I_C)$

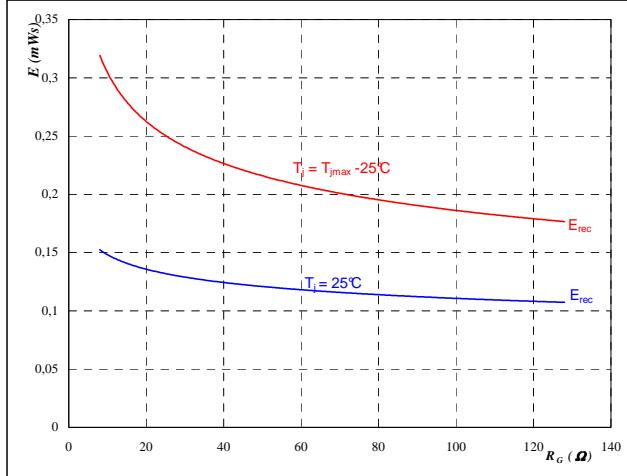


With an inductive load at

$T_j = 25/125 \text{ }^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 32 \Omega$

Brake FWD

**Figure 8**  
Typical reverse recovery energy loss  
as a function of gate resistor  
 $E_{rec} = f(R_G)$



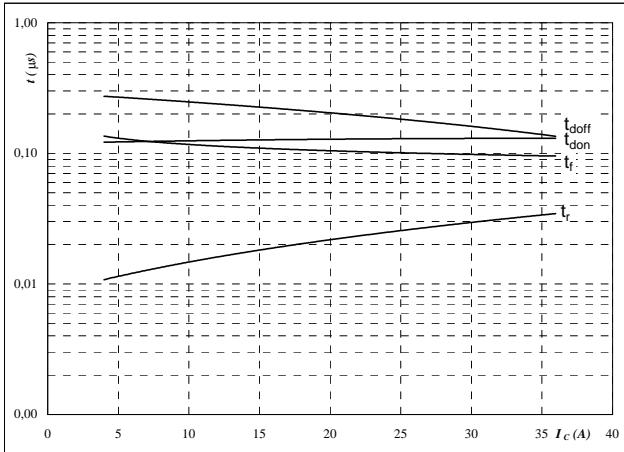
With an inductive load at

$T_j = 25/125 \text{ }^\circ\text{C}$   
 $V_{CE} = 300 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 20 \text{ A}$

## Brake

**Figure 9**

**Typical switching times as a function of collector current**  
 $t = f(I_C)$

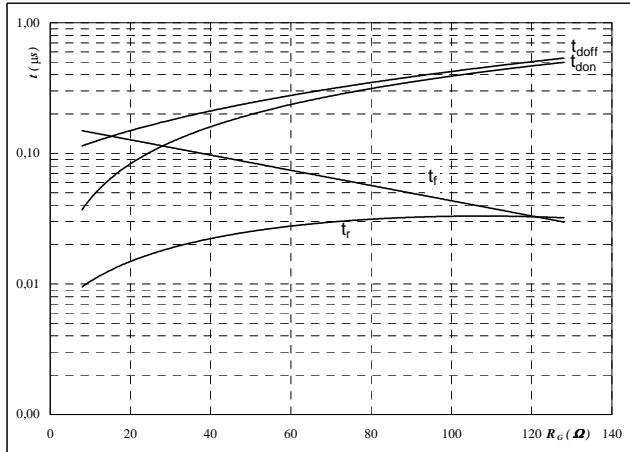


With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	32	Ω

**Brake IGBT**
**Figure 10**

**Typical switching times as a function of gate resistor**  
 $t = f(R_G)$



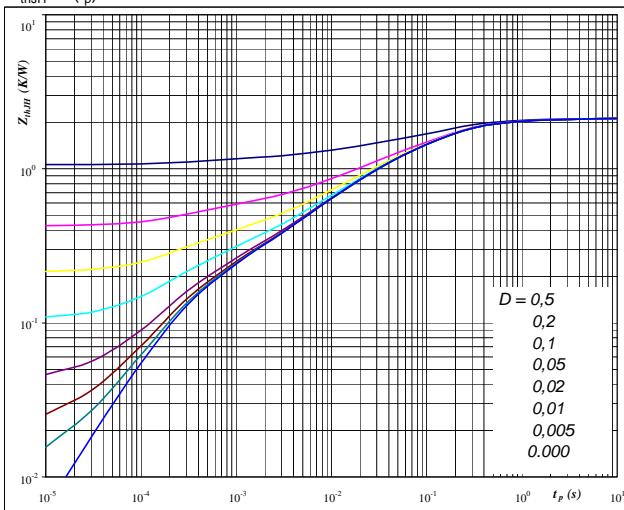
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	20	A

**Figure 11**

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$

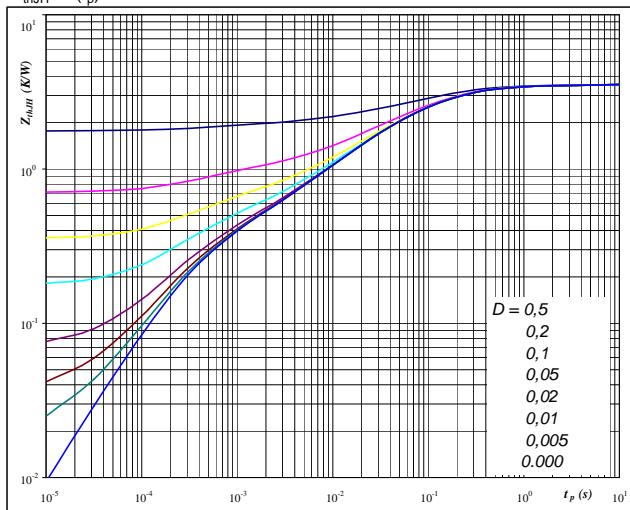


**At** Thermal grease **D =**  $t_p / T$   
 $R_{thJH} = 2,12$  K/W  $R_{thJH} = 1,83$  K/W

**Brake IGBT**
**Figure 12**

**FWD transient thermal impedance as a function of pulse width**

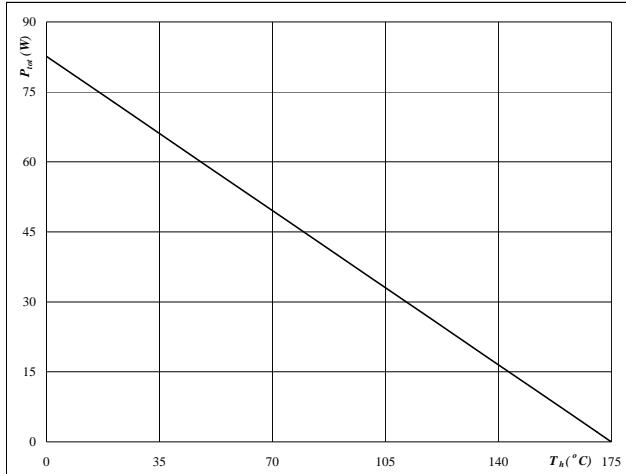
$$Z_{thJH} = f(t_p)$$



**At** Thermal grease **D =**  $t_p / T$   
 $R_{thJH} = 3,53$  K/W  $R_{thJH} = 3,07$  K/W

## Brake

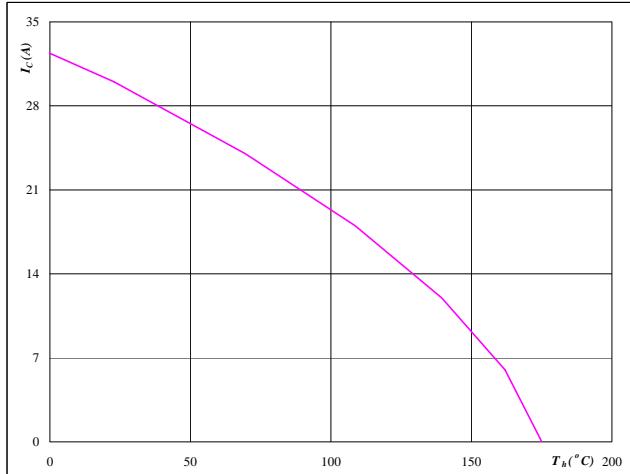
**Figure 13**  
**Power dissipation as a function of heatsink temperature**  
 $P_{\text{tot}} = f(T_h)$



At  
T<sub>j</sub> = 175 °C

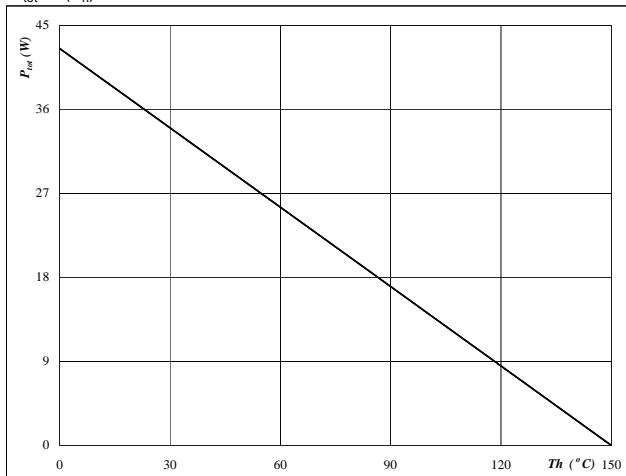
Brake IGBT

**Figure 14**  
**Collector current as a function of heatsink temperature**  
 $I_C = f(T_h)$



At  
T<sub>j</sub> = 175 °C  
V<sub>GE</sub> = 15 V

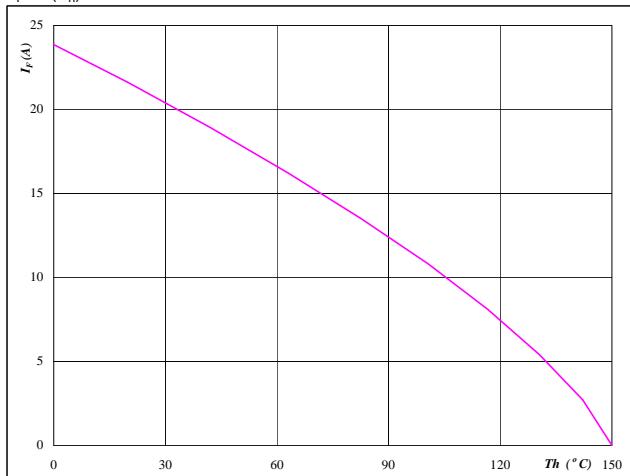
**Figure 15**  
**Power dissipation as a function of heatsink temperature**  
 $P_{\text{tot}} = f(T_h)$



At  
T<sub>j</sub> = 150 °C

Brake FWD

**Figure 16**  
**Forward current as a function of heatsink temperature**  
 $I_F = f(T_h)$



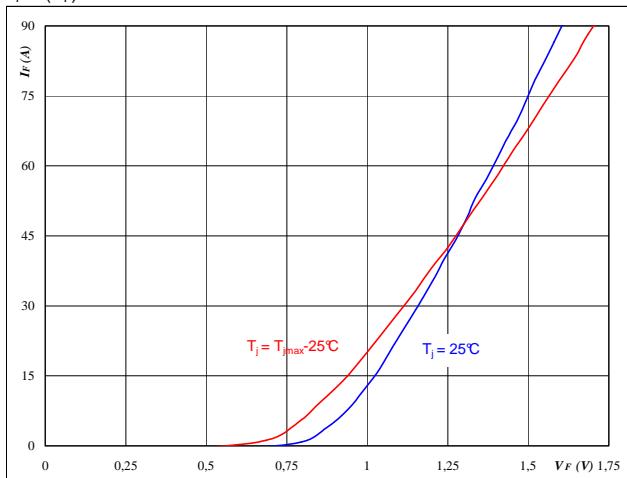
At  
T<sub>j</sub> = 150 °C

## Input Rectifier Bridge

**Figure 1**

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

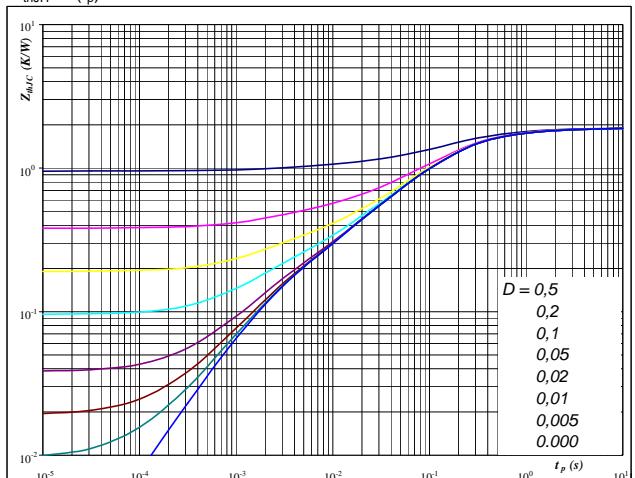

**At**

$$t_p = 250 \mu\text{s}$$

**Rectifier diode**
**Figure 2**

**Diode transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$


**At**

$$D = t_p / T$$

Thermal grease

$$R_{thJH} = 1.89 \text{ K/W}$$

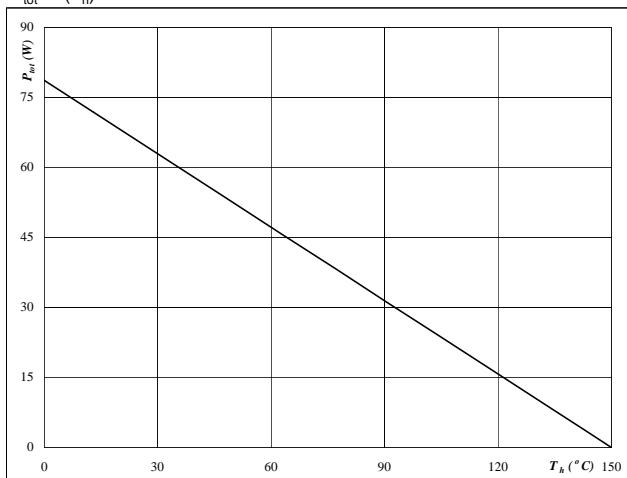
Phase change material

$$R_{thJH} = 1.62 \text{ K/W}$$

**Rectifier diode**
**Figure 3**

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_h)$$

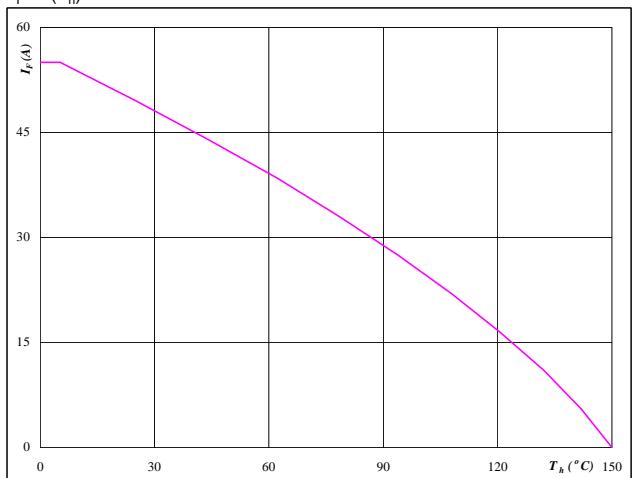

**At**

$$T_j = 150^\circ\text{C}$$

**Rectifier diode**
**Figure 4**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$


**At**

$$T_j = 150^\circ\text{C}$$

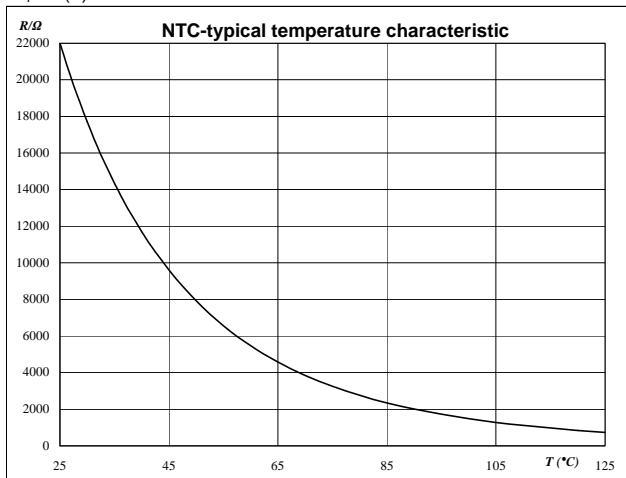
**Rectifier diode**

## Thermistor

**Figure 1**

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$


**Thermistor**
**Figure 2**

**Typical NTC resistance values**

$$R(T) = R_{25} \cdot e^{\left( B_{25/100} \left( \frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

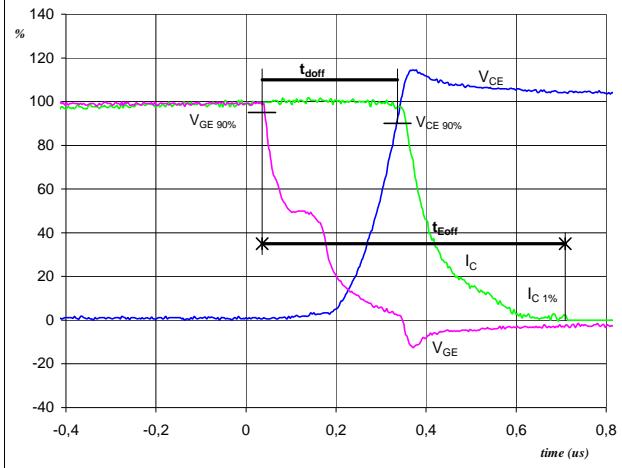
T [°C]	R <sub>nom</sub> [Ω]	R <sub>min</sub> [Ω]	R <sub>max</sub> [Ω]	△R/R [%]
-55	2089434,5	1506495,4	2672373,6	27,9
0	71804,2	59724,4	83884	16,8
10	43780,4	37094,4	50466,5	15,3
20	27484,6	23684,6	31284,7	13,8
25	22000	19109,3	24890,7	13,1
30	17723,3	15512,2	19934,4	12,5
60	5467,9	4980,6	5955,1	8,9
70	3848,6	3546	4151,1	7,9
80	2757,7	2568,2	2947,1	6,9
90	2008,9	1889,7	2128,2	5,9
<b>100</b>	<b>1486,1</b>	<b>1411,8</b>	<b>1560,4</b>	<b>5</b>
150	400,2	364,8	435,7	8,8

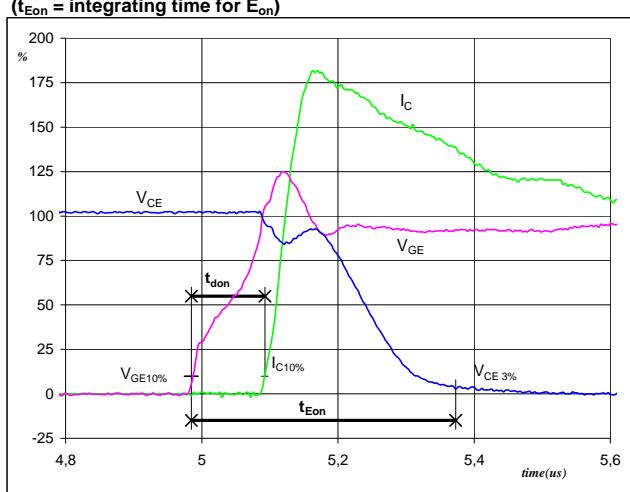
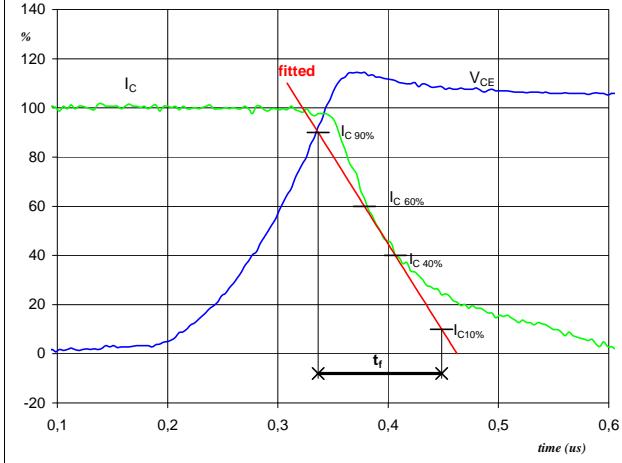
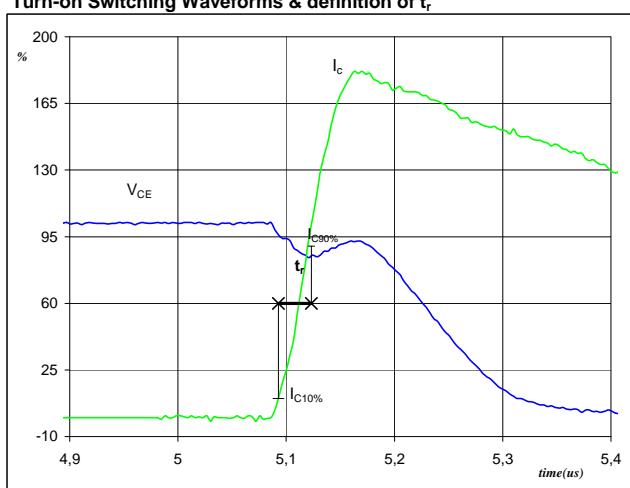
## Switching Definitions Output Inverter

**General conditions**

$T_j$	=	125 °C
$R_{gon}$	=	4Ω
$R_{goff}$	=	4Ω

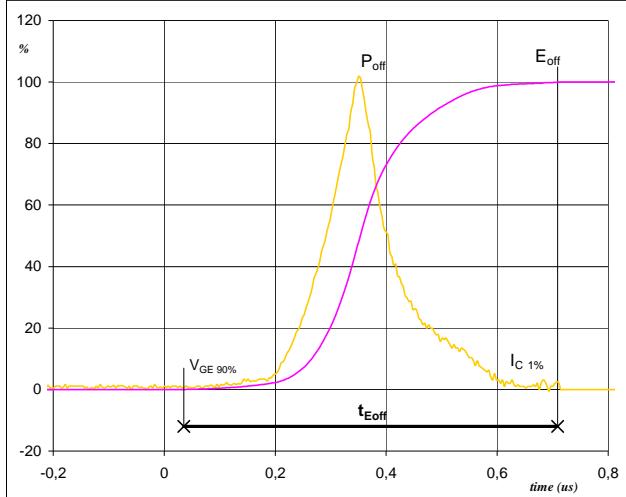
**Figure 1**
**Output inverter IGBT**
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$** 

( $t_{Eoff}$  = integrating time for  $E_{off}$ )

 $V_{GE}(0\%) = -15 \text{ V}$ 
 $V_{GE}(100\%) = 15 \text{ V}$ 
 $V_C(100\%) = 600 \text{ V}$ 
 $I_C(100\%) = 100 \text{ A}$ 
 $t_{doff} = 0,29 \mu\text{s}$ 
 $t_{Eoff} = 0,67 \mu\text{s}$ 
**Figure 2**
**Output inverter IGBT**
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$** 

( $t_{Eon}$  = integrating time for  $E_{on}$ )

 $V_{GE}(0\%) = -15 \text{ V}$ 
 $V_{GE}(100\%) = 15 \text{ V}$ 
 $V_C(100\%) = 600 \text{ V}$ 
 $I_C(100\%) = 100 \text{ A}$ 
 $t_{don} = 0,11 \mu\text{s}$ 
 $t_{Eon} = 0,39 \mu\text{s}$ 
**Figure 3**
**Output inverter IGBT**
**Turn-off Switching Waveforms & definition of  $t_f$** 

 $V_C(100\%) = 600 \text{ V}$ 
 $I_C(100\%) = 100 \text{ A}$ 
 $t_f = 0,11 \mu\text{s}$ 
**Figure 4**
**Output inverter IGBT**
**Turn-on Switching Waveforms & definition of  $t_r$** 

 $V_C(100\%) = 600 \text{ V}$ 
 $I_C(100\%) = 100 \text{ A}$ 
 $t_r = 0,03 \mu\text{s}$

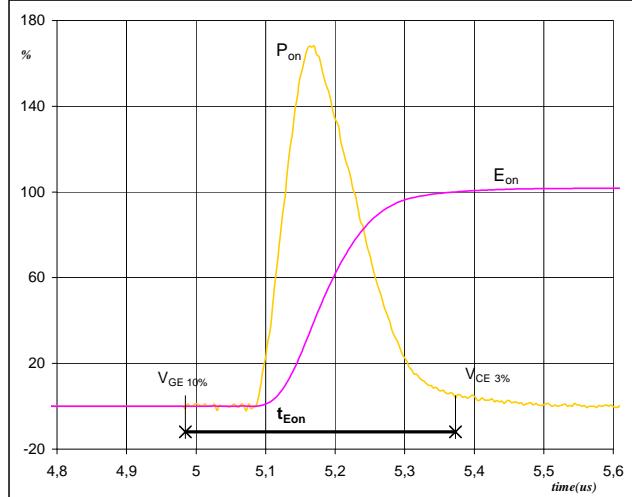
## Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



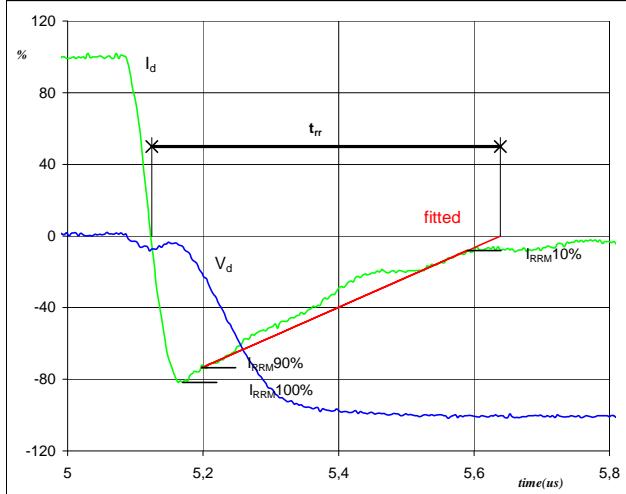
$P_{off}\ (100\%) = 59,91 \text{ kW}$   
 $E_{off}\ (100\%) = 8,87 \text{ mJ}$   
 $t_{Eoff} = 0,67 \mu\text{s}$

**Figure 6** Output inverter IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on}\ (100\%) = 59,91 \text{ kW}$   
 $E_{on}\ (100\%) = 12,48 \text{ mJ}$   
 $t_{Eon} = 0,39 \mu\text{s}$

**Figure 7** Output inverter IGBT  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



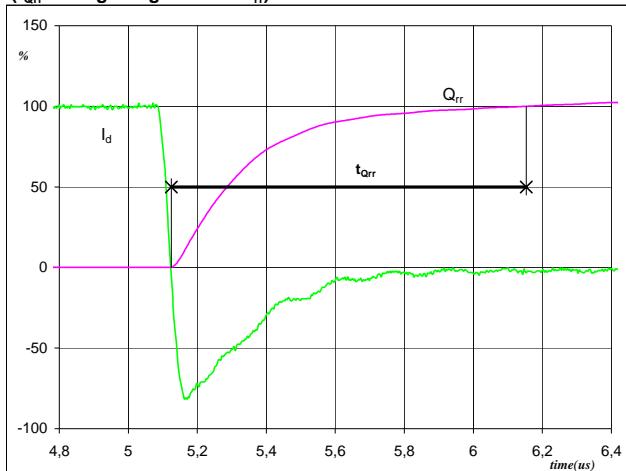
$V_d\ (100\%) = 600 \text{ V}$   
 $I_d\ (100\%) = 100 \text{ A}$   
 $I_{RRM}\ (100\%) = -83 \text{ A}$   
 $t_{rr} = 0,51 \mu\text{s}$

## Switching Definitions Output Inverter

**Figure 8**

Output inverter FWD

**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$

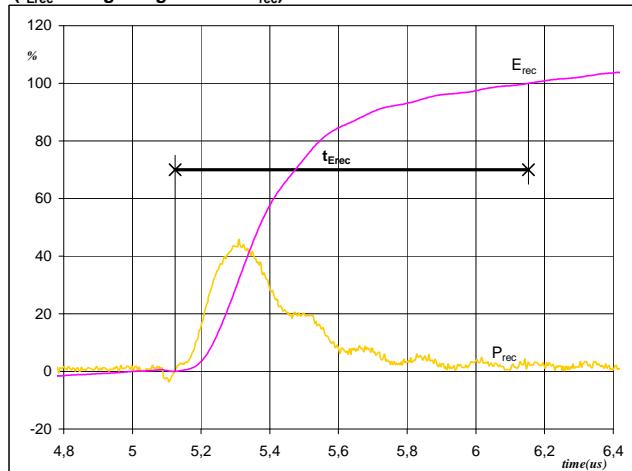


$I_d(100\%) = 100 \text{ A}$   
 $Q_{rr}(100\%) = 20,73 \mu\text{C}$   
 $t_{Qrr} = 1,03 \mu\text{s}$

**Figure 9**

Output inverter FWD

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
 $(t_{Erec} = \text{integrating time for } E_{rec})$



$P_{rec}(100\%) = 59,91 \text{ kW}$   
 $E_{rec}(100\%) = 7,85 \text{ mJ}$   
 $t_{Erec} = 1,03 \mu\text{s}$

### Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking			
Version	Ordering Code	in DataMatrix as	in packaging barcode as
17mm housing with solder pins and breake	V23990-P585-A20-PM	P585-A20-PM	P585-A20-PM
17mm housing with pressfit pins and breake	V23990-P585-A20Y-PM	P585-A20Y-PM	P585-A20Y-PM
12mm housing with solder pins and breake	V23990-P585-A208-PM	P585-A208-PM	P585-A208-PM
17mm housing with solder pins w/o breake	V23990-P585-C20-PM	P585-C20-PM	P585-C20-PM
17mm housing with pressfit pins w/o breake	V23990-P585-C20Y-PM	P585-C20Y-PM	P585-C20Y-PM

Features			
	A version	C version	
Rectifier	3-leg	3-leg	
Break IGBT	✓	w/o pin	
Break FWD	✓	1,31,32	
Inverter IGBT	✓	✓	
Inverter FWD	✓	✓	

Outline																																																																														
<table border="1"> <thead> <tr> <th>Pin table</th><th>X</th><th>Y</th></tr> </thead> <tbody> <tr><td>1</td><td>52,55</td><td>0</td></tr> <tr><td>2</td><td>47,7</td><td>0</td></tr> <tr><td>3</td><td>44,8</td><td>0</td></tr> <tr><td>4</td><td>37,8</td><td>0</td></tr> <tr><td>5</td><td>37,8</td><td>2,8</td></tr> <tr><td>6</td><td>35</td><td>0</td></tr> <tr><td>7</td><td>35</td><td>2,8</td></tr> <tr><td>8</td><td>28</td><td>0</td></tr> <tr><td>9</td><td>25,2</td><td>0</td></tr> <tr><td>10</td><td>22,4</td><td>0</td></tr> <tr><td>11</td><td>19,6</td><td>0</td></tr> <tr><td>12</td><td>16,8</td><td>0</td></tr> <tr><td>13</td><td>14</td><td>0</td></tr> <tr><td>14</td><td>11,2</td><td>0</td></tr> <tr><td>15</td><td>8,4</td><td>0</td></tr> <tr><td>16</td><td>5,6</td><td>0</td></tr> <tr><td>17</td><td>2,8</td><td>0</td></tr> <tr><td>18</td><td>0</td><td>0</td></tr> <tr><td>19</td><td>0</td><td>28,5</td></tr> <tr><td>20</td><td>2,8</td><td>28,5</td></tr> <tr><td>21</td><td>7,5</td><td>28,5</td></tr> <tr><td>22</td><td>14,5</td><td>28,5</td></tr> <tr><td>23</td><td>17,3</td><td>28,5</td></tr> <tr><td>24</td><td>22</td><td>28,5</td></tr> </tbody> </table>	Pin table	X	Y	1	52,55	0	2	47,7	0	3	44,8	0	4	37,8	0	5	37,8	2,8	6	35	0	7	35	2,8	8	28	0	9	25,2	0	10	22,4	0	11	19,6	0	12	16,8	0	13	14	0	14	11,2	0	15	8,4	0	16	5,6	0	17	2,8	0	18	0	0	19	0	28,5	20	2,8	28,5	21	7,5	28,5	22	14,5	28,5	23	17,3	28,5	24	22	28,5			
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Pinout			
DC+ (4,5)	INV+ (6,7)	BRC (31)	BRE (32) optional
L1 (28)	G1 (20)	S1 (21)	U (19)
L1 (28)	G3 (23)	S3 (24)	V (22)
L1 (30)	G5 (26)	S5 (27)	W (25)
DC+ (2,3)	G2 (17)	S2 (18)	T
	G4 (14)	S4 (15)	R1 (8)
	G6 (11)	S6 (12)	R2 (9)

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